TELEFUNKEN Semiconductors

High Efficiency LED in ø 3 mm Package

Color	Type Technology		Angle of half intensity		
			±φ		
Soft orange	TLHO4200	GaAsP on GaP	22°		

Description

This family of 3 mm lamps is specially designed for applications requiring a high on-axis intensity in soft orange.

The light generated is focused to a narrow beam to achieve this effect.

Features

- High intensity
- Standard 3 mm (T-1) package
- Narrow viewing angle
- Reliable and rugged
- 605 nm orange
- Wavelength categorized
- Luminous intensity categorized

Applications

Indicator lamp OFF / ON indicator Backlight illumination Readout lamp

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TLHO420.

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Absolute Maximum Ratings

 $T_{amb} = 25$ °C, unless otherwise specified

Soft orange (TLHO4200)

Parameter	Test Conditions	Туре	Symbol	Value	Unit
Reverse voltage			V_{R}	6	V
DC forward current			I_{F}	30	mA
Surge forward current	$t_p \le 10 \ \mu s$		I_{FSM}	1	A
Power dissipation	$T_{amb} \le 30$ °C		P_{V}	100	mW
Junction temperature			T_{i}	100	°C
Operating temperature range			T _{amb}	-20 to +100	°C
Storage temperature range			T_{stg}	-55 to +100	°C
Soldering temperature	$t \le 5 \text{ s}, 2 \text{ mm}$		T_{sd}	260	°C
	from body				
Thermal resistance junction/ambient			R_{thJA}	700	K/W

Optical and Electrical Characteristics

 $T_{amb} = 25$ °C, unless otherwise specified

Soft orange (TLHO4200)

Parameter	Test Conditions	Туре	Symbol	Min	Тур	Max	Unit
Luminous intensity	$I_F = 10 \text{ mA}, I_{Vmin}/I_{Vmax} \ge 0.5$		I_{V}	4	10		mcd
Dominant wavelength	$I_F = 10 \text{ mA}$		$\lambda_{ m d}$	598		611	nm
Peak wavelength	$I_F = 10 \text{ mA}$		λ_{p}		605		nm
Angle of half intensity	$I_F = 10 \text{ mA}$		φ		±22		deg
Forward voltage	$I_F = 20 \text{ mA}$		V_{F}		2.4	3	V
Reverse current	$V_R = 6 V$		I_R			10	μΑ
Junction capacitance	$V_R = 0$, $f = 1$ MHz		Cj		50		pF

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Typical Characteristics ($T_{amb} = 25$ °C, unless otherwise specified)

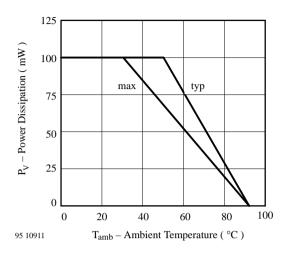


Figure 1. Power Dissipation vs. Ambient Temperature

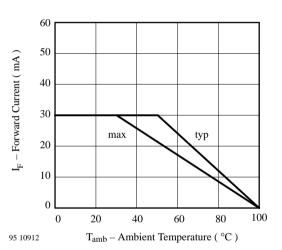


Figure 2. Forward Current vs. Ambient Temperature

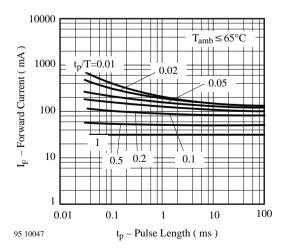


Figure 3. Forward Current vs. Pulse Length

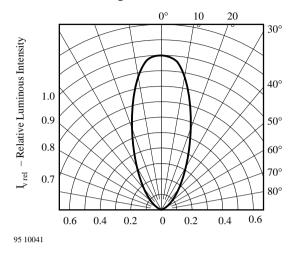


Figure 4. Rel. Luminous Intensity vs. Angular Displacement

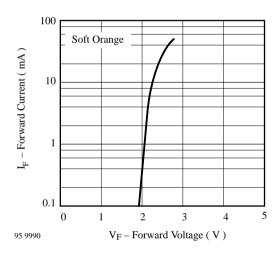


Figure 5. Forward Current vs. Forward Voltage

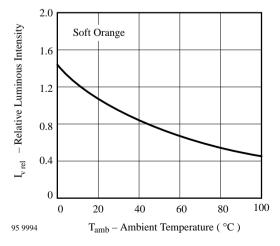


Figure 6. Rel. Luminous Intensity vs. Ambient Temperature

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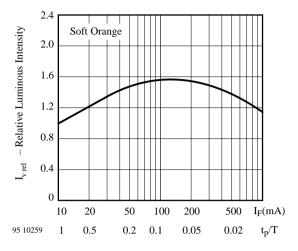


Figure 7. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

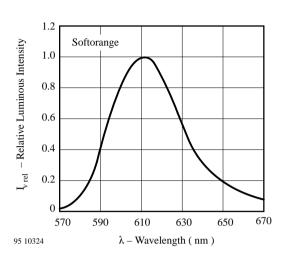


Figure 9. Relative Luminous Intensity vs. Wavelength

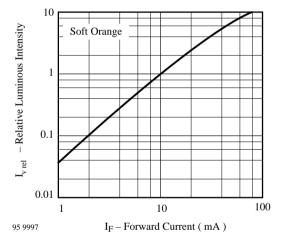


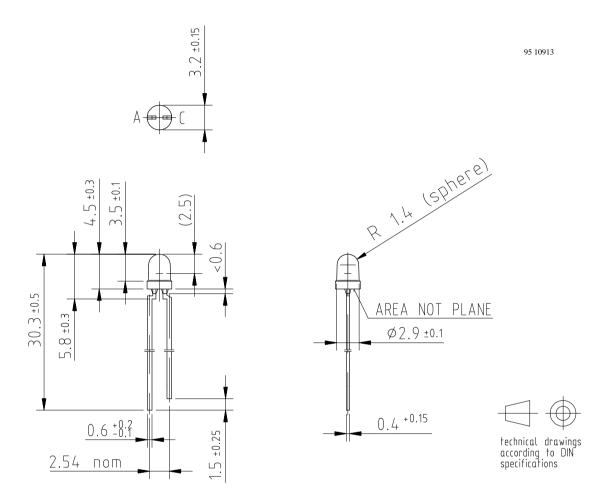
Figure 8. Relative Luminous Intensity vs. Forward Current

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Dimensions in mm



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Ozone Depleting Substances Policy Statement

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or

unauthorized use.

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